

TSSP60..

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IR Sensor Module for Reflective Sensor, Light Barrier, and Fast Proximity Applications



LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

The TSSP60.. series are compact infrared detector modules for presence and fast proximity sensing applications. They provide an active low output in response to infrared bursts at 940 nm. The frequency of the burst should correspond to the carrier frequency shown in the parts table. This component has not been qualified according to automotive specifications.

FEATURES

- Presence sensor: up to 2 m distance, find more info at: <u>www.vishay.com/doc?49009</u>
- Light barrier: up to 12 m distance, TSAL6200 with I_F = 50 mA, find more info at: www.vishay.com/doc?49650



- Fast proximity: up to 2 m range at 5 ms response time, find more info at: <u>www.vishav.com/doc?82741</u>
- RoHS COMPLIANT HALOGEN FREE GREEN (5-2008)

- Supply voltage: 2.0 V to 5.5 V
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

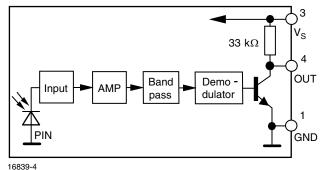
DESIGN SUPPORT TOOLS

- <u>3D models</u>
- Window size calculator

APPLICATIONS

- Reflective sensors for hand dryers, towel or soap dispensers, water faucets, toilet flush
- Vending machine fall detection
- Security and pet gates
- · Person or object vicinity switch
- Fast proximity sensors for toys, robotics, drones, and other consumer and industrial uses

BLOCK DIAGRAM



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Taping:



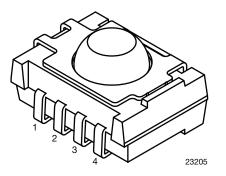
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MECHANICAL DATA

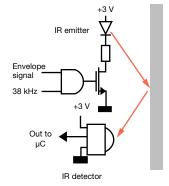
Pinning

 $1 = GND, 2 = N.C., 3 = V_S, 4 = OUT$



TSSP60..TT - top view taped, 1190 pcs/reel TSSP60..TR - side view taped, 1120 pcs/reel

PRESENCE SENSING



ORDERING CODE

PARTS TABLE				
Carrier frequency	38 kHz	TSSP6038		
	56 kHz	Hz TSSP6056		
Package		Panhead		
Pinning		1 = GND, 2 = N.C., 3 = V _S , 4 = OUT		
Dimensions (mm)		7.5 W x 5.3 H x 4.0 D		
Mounting		SMD		
Application		Presence sensors, fast proximity sensors		
Special options		 Narrow optical filter: <u>www.vishay.com/doc?81590</u> Wide optical filter: <u>www.vishay.com/doc?82726</u> 		

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Supply voltage		V _S	-0.3 to +6	V	
Supply current		I _S	5	mA	
Output voltage		Vo	-0.3 to (V _S + 0.3)	V	
Output current		lo	5	mA	
Junction temperature		Тj	100	°C	
Storage temperature range		T _{stg}	-25 to +85	°C	
Operating temperature range		T _{amb}	-25 to +85	°C	
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW	

Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability



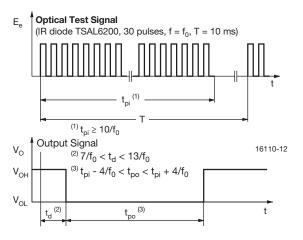
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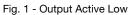
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ELECTRICAL AND OPTICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current (pin 3)	$E_v = 0, V_S = 3.3 V$	I _{SD}	0.25	0.35	0.45	mA
Supply current (pirt 3)	$E_v = 40$ klx, sunlight	I _{SH}	-	0.45	-	mA
Supply voltage		Vs	2.0	-	5.5	V
Transmission distance	$E_v = 0$, test signal see Fig. 1, IR diode TSAL6200, I _F = 50 mA	d	-	8	-	m
Output voltage low (pin 1)	$I_{OSL} = 0.5 \text{ mA}, E_e = 2 \text{ mW/m}^2,$ test signal see Fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	$\begin{array}{l} \mbox{Pulse width tolerance:} \\ t_{pi} - 4/f_o < t_{po} < t_{pi} + 4/f_o, \\ \mbox{test signal see Fig. 1} \end{array}$	E _{e min.}	-	0.7	1.2	mW/m ²
Maximum irradiance	$\begin{array}{l} \mbox{Pulse width tolerance:} \\ t_{pi} - 4/f_o < t_{po} < t_{pi} + 4/f_o, \\ \mbox{test signal see Fig. 1} \end{array}$	E _{e max} .	30	-	-	W/m ²
Directivity	Angle of half transmission distance	Φ1/2	-	± 50	-	0

TYPICAL CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)





Input burst length

E_e - Irradiance (mW/m²)

Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

1000

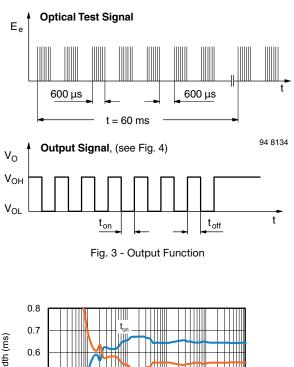
100 000

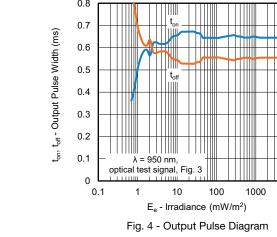
Output pulse width

 $\lambda = 950 \text{ nm},$

optical test signal, Fig.

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1.0

0.9

0.8

0.7

0.6

0.5

0.4

0.3

0.2

0.1

0.0

0.1

tpo - Output Pulse Width (ms)

3

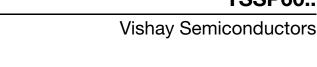
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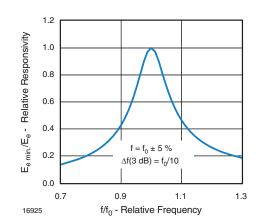


Fig. 5 - Frequency Dependence of Responsivity

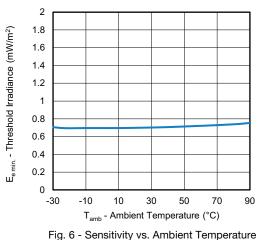


Fig. 6 - Sensitivity vs. Ambient Temperature

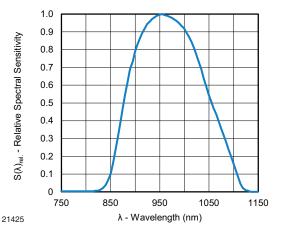
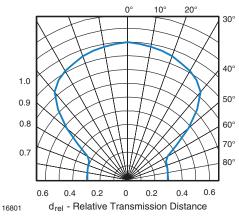
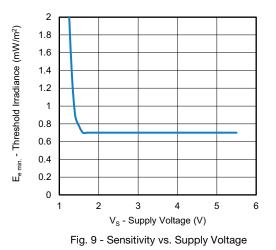


Fig. 7 - Relative Spectral Sensitivity vs. Wavelength



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Fig. 8 - Directivity



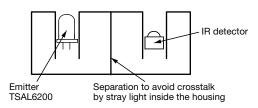


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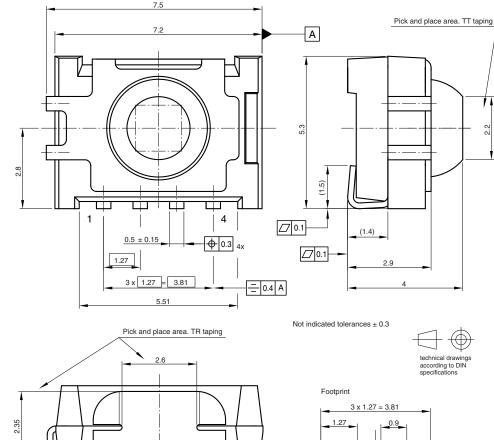
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The typical application of these devices is a reflective or beam break sensor with active low "detect" or "no detect" information contained in its output. The TSSP6056 is also suitable for fast (~ 5 ms) proximity sensor applications for ranges between 10 cm and 2 m. Please see application note "Vishay's TSSP4056 Sensor for Fast Proximity Sensing" (www.vishay.com/doc?82741).

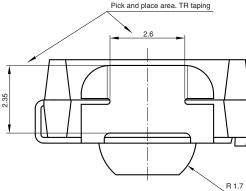
Example for a sensor hardware:

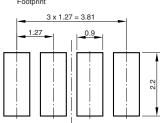


There should be no common window in front of the emitter and detector in order to avoid crosstalk via guided light through the window.



PACKAGE DIMENSIONS in millimeters





Drawing-No.: 6.544-5341.01-4 Issue: 8; 02.09.09 16776

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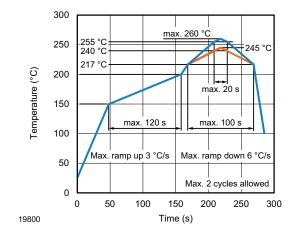
ASSEMBLY INSTRUCTIONS

Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off



VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE

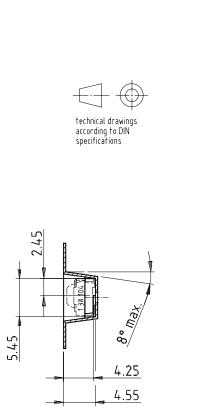
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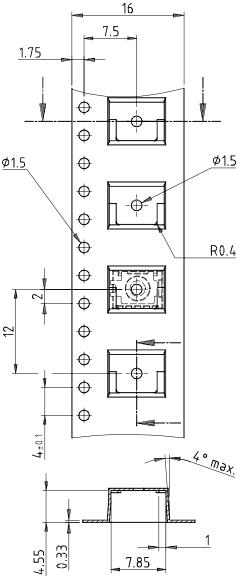


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TAPING VERSION TSSP60..TT DIMENSIONS in millimeters





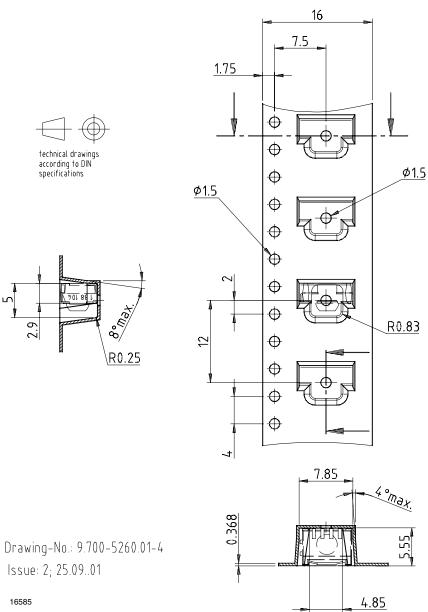
Drawing-No.: 9.700-5259.01-4 Issue: 1; 05.09.01 16584



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TAPING VERSION TSSP60..TR DIMENSIONS in millimeters



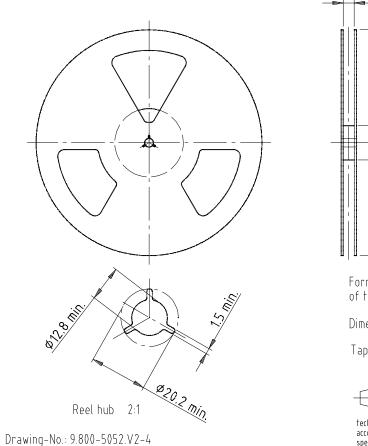


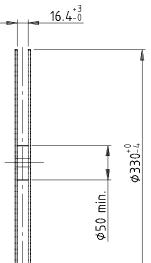
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REEL DIMENSIONS in millimeters





Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

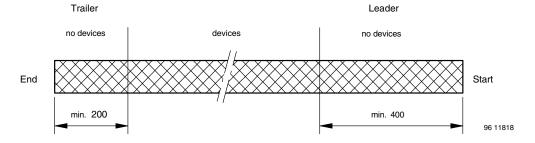
Tape width 16



technical drawings according to DIN specifications



LEADER AND TRAILER DIMENSIONS in millimeters



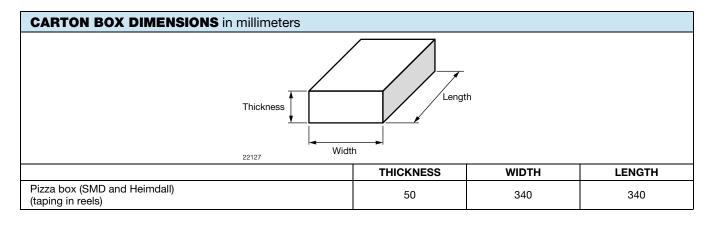


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OUTER PACKAGING

The sealed reel is packed into a pizza box.



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min. ± 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)				
PLAIN WRITING	ABBREVIATION	LENGTH		
Item-description	-	18		
Item-number	INO	8		
Selection-code	SEL	3		
LOT-/serial-number	BATCH	10		
Data-code	COD	3 (YWW)		
Plant-code	PTC	2		
Quantity	QTY	8		
Accepted by	ACC	-		
Packed by	PCK	-		
Mixed code indicator	MIXED CODE	-		
Origin	XXXXXXX+	Company logo		
LONG BAR CODE TOP	ТҮРЕ	LENGTH		
Item-number	Ν	8		
Plant-code	Ν	2		
Sequence-number	Х	3		
Quantity	Ν	8		
Total length	-	21		
SHORT BAR CODE BOTTOM	TYPE	LENGTH		
Selection-code	Х	3		
Data-code	Ν	3		
Batch-number	Х	10		
Filter	-	1		
Total length	_	17		

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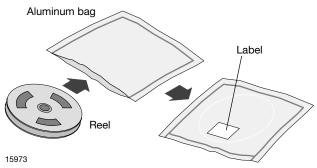


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DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 $^{\circ}\text{C}$ + 5 $^{\circ}\text{C}$ and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard J-STD-020 level 4 label is included on all dry bags.

LEVEL CAUTION This bag contains MOISTURE-SENSITIVE DEVICES L Shelf life in sealed bag: 12 months at < 40 °C and < 90 % relative 1. humidity (RH) After this bag is opened, devices that will be subjected to soldering reflow or equivalent processing (peak package body temp. 260 °C) must be 2. Mounted within 72 hours at factory condition of < 30 °C/60 % RH or 2a 2b. Stored at < 5 % RH Devices require baking befor mounting if: Humidity Indicator Card is > 10 % when read at 23 $^\circ\text{C}$ ± 5 $^\circ\text{C}$ or З. 2a. or 2b. are not met. 4. If baking is required, devices may be baked for: 192 hours at 40 °C + 5 °C/ 0 °C and < 5 % RH (dry air/nitrogen) or 96 hours at 00 °C ± 5 °C and < 5 % RH for all device containers or 24 hours at 125 °C ± 5 °C not suitable for reels or tubes Bag Seal Date: (If blank, see barcode label) Level and body temperature defined by EIA JEDEC Standard J-STD-020

EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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